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**\*EXAMINER:** Initial if reference coincide, whether or not citation is in conformance with MPPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant. <sup>1</sup> Applicant's unique citation designation number (optional). <sup>2</sup> See Kind Codes of USPTO Patent Documents at [www.uspto.gov](http://www.uspto.gov) or MPPEP 901.04. <sup>3</sup> Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). <sup>4</sup> For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. <sup>5</sup> Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST.16 if possible. <sup>6</sup> Applicant is to place a check mark here if English language Translation is attached.

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Substitute for form 1449/PTO				<b>Complete if Known</b>	
<b>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</b>  (Use as many sheets as necessary)				Application Number	10/589,399
				Filing Date	August 14, 2006
				First Named Inventor	Guo-Quan LU
				Art Unit	1793
				Examiner Name	Takeuchi
Sheet	2	of	2	Attorney Docket Number	124617-00118

NON PATENT LITERATURE DOCUMENTS				
Examiner Initials	Cite No. <sup>1</sup>	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T <sup>2</sup>	
	A	Zhang, et al. "Nanoscale Silver Sintering for High-Temperature Packaging of Semiconductor Devices," TMS (The Minerals & Materials Society), 2004, 5 pp.		
	B	Bai, Guofeng, "Low Temperature Sintering of Nanoscale Silver Paste for Semiconductor Device Interconnection," Dissertation, Copyright 2005, 196 pp.		

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